

Title (en)

ELECTROLYTIC BATH FOR THE DEPOSITION AND PENETRATION OF METALLIC COATINGS ON METALLIC SUBSTRATES

Publication

**EP 0066347 B1 19870415 (EN)**

Application

**EP 82300140 A 19820112**

Priority

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- US 31967281 A 19811109
- US 33528281 A 19811228

Abstract (en)

[origin: EP0066347A1] A solution for the fusion of a second metal to a first metal is provided which comprises 0.10 to 10% of the second metal in a dissociable form; and a solvent chosen from water, an organic solvent or a mixture thereof, the solution having a conductivity in the range 10 to 80 ohms cm.

IPC 1-7

**C25D 5/18**

IPC 8 full level

**C25D 5/18** (2006.01); **C25D 17/14** (2006.01)

CPC (source: EP KR US)

**C25D 3/02** (2013.01 - KR); **C25D 5/18** (2013.01 - EP US); **C25D 5/605** (2020.08 - EP US); **C25D 5/623** (2020.08 - EP US); **C25D 5/627** (2020.08 - EP US); **C25D 17/14** (2013.01 - EP US); **C25D 5/18** (2013.01 - KR); **C25D 5/605** (2020.08 - KR); **C25D 5/623** (2020.08 - KR); **C25D 5/627** (2020.08 - KR); **Y10S 204/09** (2013.01 - KR)

Citation (examination)

Kuhn: Industrial Electrochemical Processes N.Y. (1971) Elsevier Publ. p. 354/55

Cited by

CN103469460A; US6416712B2; US6200529B1; WO2012040503A3; WO0107682A1

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